



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

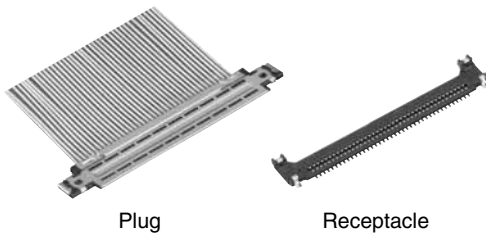
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



For board-to-micro coaxial wire

Micro coaxial connectors (Low profile)

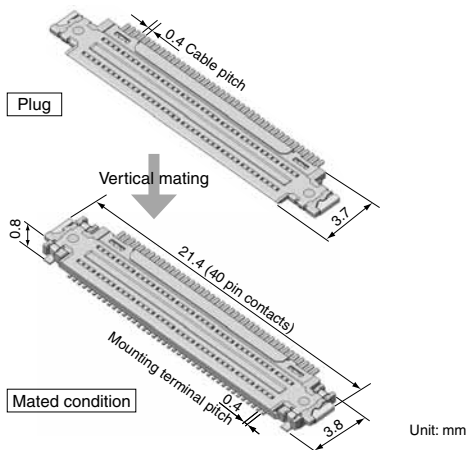
CF Series



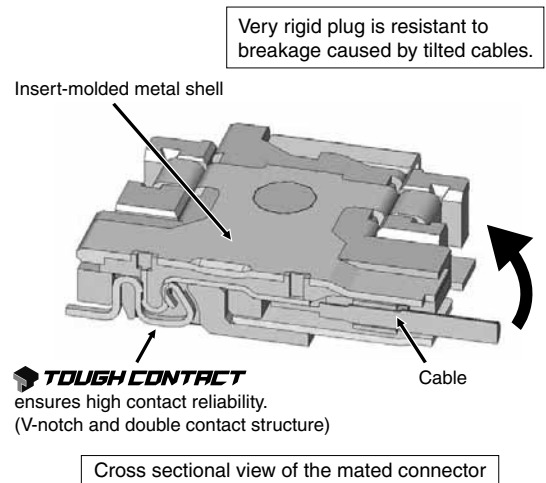
RoHS compliant

FEATURES

1. Vertical mating type with a 0.8 mm mated height low profile design



- 2. **"TOUGH CONTACT"** with strong resistance to various environments provides high contact reliability and facilitates connection work with tactile feedback.
- 3. **Highly rigid plug**
An insert-molded metal shell covers the entire top surface of the plug.

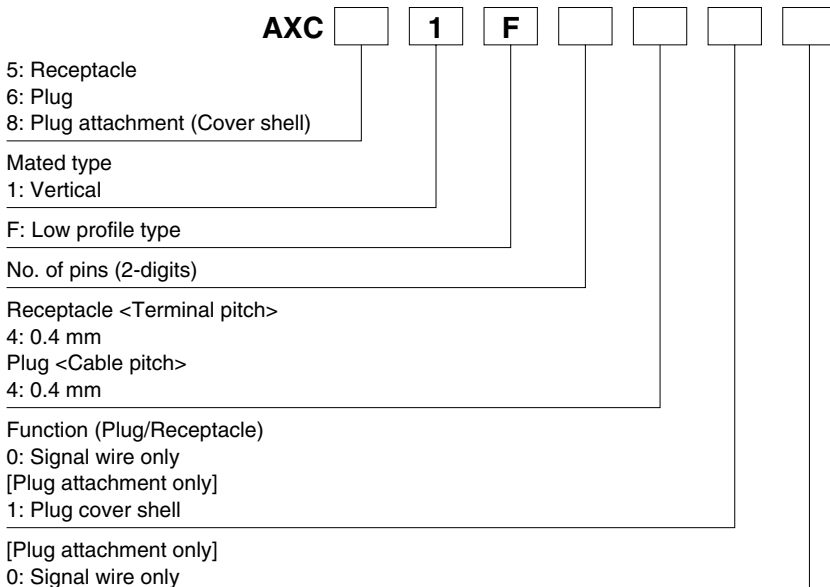


4. **Compatible wires: Coaxial AWG #42 to #46 (outer diameter: 0.29 mm or less), Coaxial AWG #38 (outer diameter: 0.30 mm or less)**

APPLICATIONS

Tablets, laptops, mobile phones, digital still cameras and digital video cameras.

ORDERING INFORMATION



PRODUCT TYPES

1. Receptacle

Mated height	Number of pins	Part number	Packing	
		Receptacle (Board side)	Inner carton (1-reel)	Outer carton
0.8mm	40	AXC51F4040	5,000 pcs.	10,000 pcs.

2. Plug (unit)

Mated height	Number of pins	Part number	Packing	
		Plug (Cable side)	Inner carton (1-reel)	Outer carton
0.8mm	40	AXC61F4040	5,000 pcs.	10,000 pcs.

3. Plug cover shell

Mated height	Number of pins	Part number	Packing	
		Plug cover shell (Plug side)	Inner carton (1-reel)	Outer carton
0.8mm	40	AXC81F40410	5,000 pcs.	10,000 pcs.

Notes: 1. Order unit:

For volume production: 1-inner carton (1-reel) units

Samples for mounting check: 50-connector units. Please contact our sales office.

2. Please contact us for connectors having a number of pins other than those listed above.

SPECIFICATIONS

1. Characteristics

Item		Specifications	Conditions																		
Electrical characteristics (Connector unit)	Rated current	0.30A/terminal (Max. 4A at total pin contacts)	Maximum current that 1 pin contact can conduct. (connector characteristic except cable)																		
	Rated voltage	50V AC/DC																			
	Insulation resistance	Min. 1,000MΩ (initial)	Using 250 V DC megger (applied for 1 minute)																		
	Breakdown voltage	150V AC for 1 minute	Rated voltage is applied for one minute and check for short circuit or damage with a detection current of 1mA.																		
	Contact resistance	Signal: Max. 70mΩ (initial) Ground: Max. 40mΩ (initial)	Based on method of JIS C 5402 Calculating GND resistance as parallel resistance of all the metal brackets.																		
Applicable electrical wire		AWG #42, 44, 46 (Outside diameter: 0.29mm or less) AWG #38 (Outside diameter: 0.30mm or less)																			
Mechanical characteristics	Composite insertion force	Max. 1.2 × No. of pins + 19.2N (initial)																			
	Composite removal force	Min. 0.165 × No. of pins + 0.33N																			
	Holding force for terminal (Receptacle)	Contact: Min. 0.16N/terminal Soldering terminal: Min. 0.20N/terminal	Measured the maximum load applied until the press-fit terminals were removed in the axial direction.																		
	Wire tensile strength	Min. 5N	When all wires bundled together are pulled, the mated joint must not break. Pulling direction: Wire leading direction																		
Environmental characteristics	Ambient temperature	-55°C to +85°C	No freezing at low temperatures. No dew condensation.																		
	Storage environment	-55°C to +85°C (Product unit) -40°C to +50°C (Packing style)	No freezing at low temperatures. No dew condensation.																		
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100MΩ, increment of contact resistance max. 40mΩ	Conformed to MIL-STD-202F, method 107G <table border="1"> <thead> <tr> <th>Order</th> <th>Temperature (°C)</th> <th>Time (minutes)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55₋₃⁰</td> <td>30</td> </tr> <tr> <td>2</td> <td>∩</td> <td>Max. 5</td> </tr> <tr> <td>3</td> <td>85⁺³₀</td> <td>30</td> </tr> <tr> <td>4</td> <td>∩</td> <td>Max. 5</td> </tr> <tr> <td></td> <td>-55₋₃⁰</td> <td></td> </tr> </tbody> </table>	Order	Temperature (°C)	Time (minutes)	1	-55 ₋₃ ⁰	30	2	∩	Max. 5	3	85 ⁺³ ₀	30	4	∩	Max. 5		-55 ₋₃ ⁰	
	Order	Temperature (°C)	Time (minutes)																		
	1	-55 ₋₃ ⁰	30																		
	2	∩	Max. 5																		
	3	85 ⁺³ ₀	30																		
4	∩	Max. 5																			
	-55 ₋₃ ⁰																				
Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100MΩ, increment of contact resistance max. 40mΩ	MIL-STD-1344A, METHOD 1002 Bath temperature 40±2°C, humidity 90 to 95% R.H.																			
Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100MΩ, increment of contact resistance max. 40mΩ	MIL-STD-1344A, METHOD 1001 Bath temperature 35±2°C, saltwater concentration 5±1%																			
H ₂ S resistance (header and socket mated)	48 hours, increment of contact resistance max. 40mΩ	JEIDA-38-1984 Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.																			
Insertion and removal life	Mechanical life: 30 times, increment of contact resistance max. 40mΩ Min. 0.165 composite removal force × No. of pins + 0.33N	Repeated insertion and removal speed of max. 200 times/hours																			
Resistance to soldering heat	Receptacle	Initial electrical and mechanical characteristics must be maintained.	Reflow soldering: Max. peak temperature of 260°C, 2 cycles (PC board surface temperature of near connector terminals) Soldering iron: 350°C within 3s, 300°C within 5s																		
	Plug	Initial electrical and mechanical characteristics must be maintained.	Connecting wires portion pulse heat: Max. peak temperature of 300°C, 3s (Don't touch the heater head to molded portion) Plug cover shell soldering portion: Soldering iron: 350°C within 3s, 300°C within 5s																		

2. Material and surface treatment

1. Receptacle

Part name	Material	Color	Surface treatment
Molded portion	LCP resin (UL 94V-0)	Black	—
Contact	Copper alloy	—	Contact portion: Ni plating on base, Au plating on surface (Min. 0.1μm) Soldering portion: Ni plating on base, Au plating on surface (Except for front edge of terminal)
Soldering terminals	Copper alloy	—	Contact portion: Ni plating on base, Au plating on surface Soldering portion: Ni plating on base, Au plating on surface (Except for front edge of terminal)

2. Plug

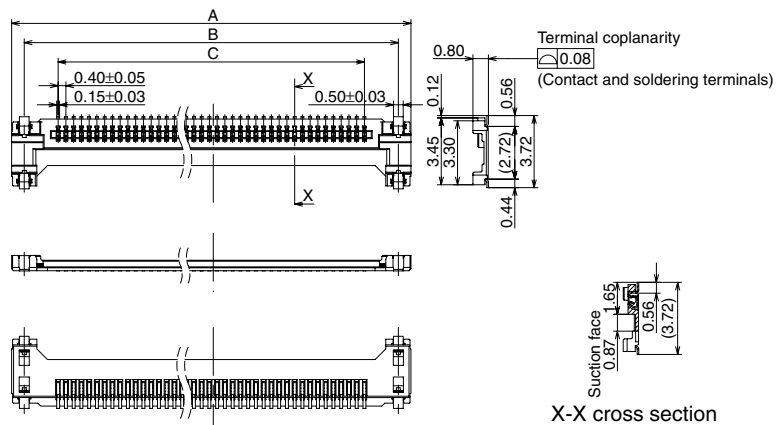
Part name	Material	Color	Surface treatment
Molded portion	LCP resin (UL 94V-0)	Black	—
Post	Copper alloy	—	Contact portion: Ni plating on base, Au plating on surface (Min. 0.1μm) Soldering wire portion: Ni plating on base, Au plating on surface
Insert shell	Copper alloy	—	Ni plating on base, Au plating on surface

3. Plug cover shell

Part name	Material	Color	Surface treatment
Shell	Copper alloy	—	Ni plating

DIMENSIONS (Unit: mm)

• Receptacle

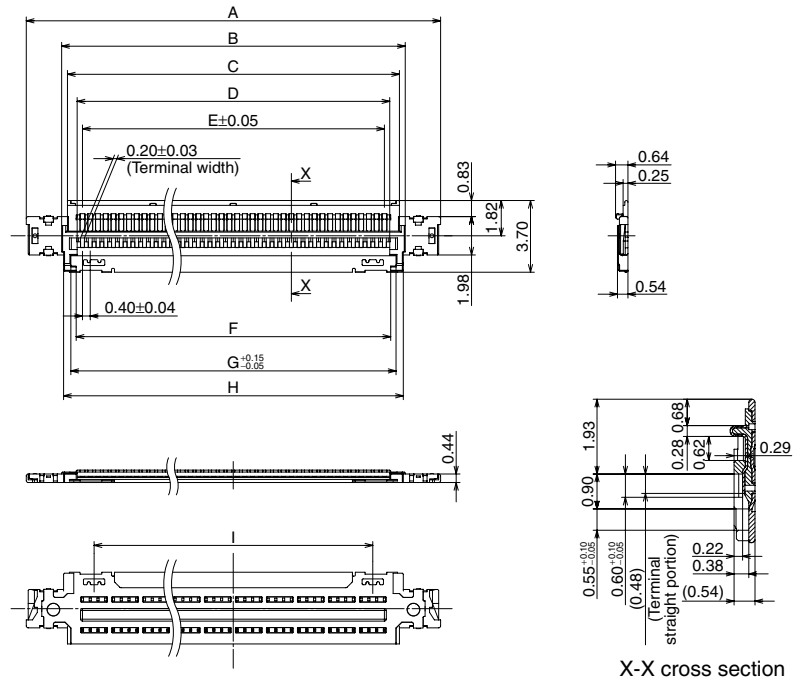
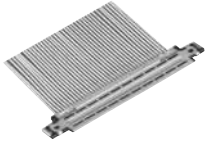


Dimension table (mm)

Number of pins/ dimension	A	B	C
40	20.40	19.10	15.60

General tolerance: ±0.2

• Plug (unit)



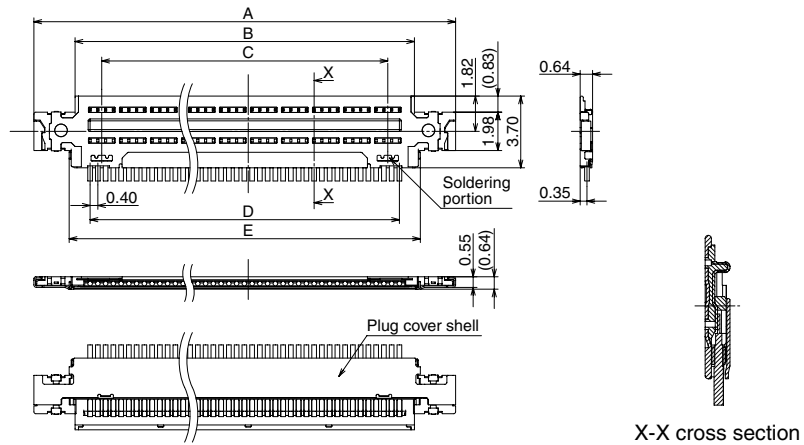
Dimension table (mm)

Number of pins/ dimension	A	B	C	D	E	F	G	H	I
40	21.40	17.75	17.15	16.15	15.60	16.25	16.80	17.55	14.40

General tolerance: ±0.2

• Plug (assembled condition)

Regarding cable pattern, please refer to "Notes".

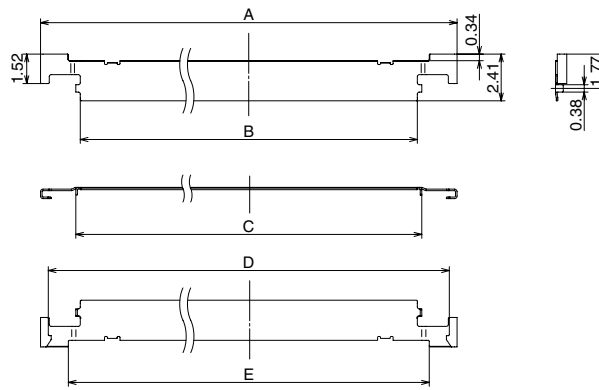


Dimension table (mm)

Number of pins/ dimension	A	B	C	D	E
40	21.40	17.15	14.40	15.60	17.76

General tolerance: ±0.2

• Plug cover shell

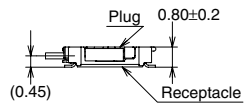


Dimension table (mm)

General tolerance: ± 0.2

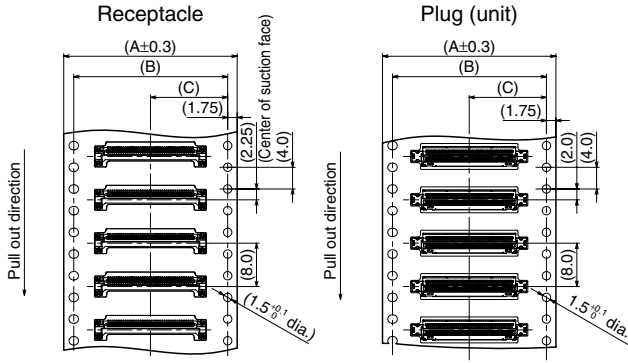
Number of pins/ dimension	A	B	C	D	E
40	21.40	17.30	17.76	20.60	18.53

• Receptacle and Plug are mated

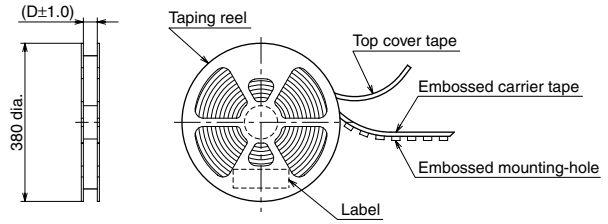


EMBOSSED TAPE DIMENSIONS (Unit: mm)

• Tape dimensions



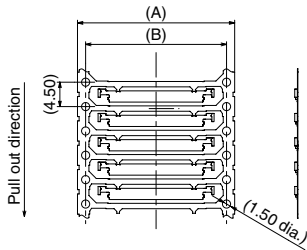
• Plastic reel dimensions (Conforming to EIAJ ET-7200B)



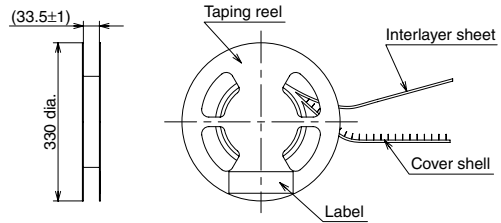
Dimension table (mm)

Common for receptacle and plug	Number of pins	A	B	C	D
	40	32.0	28.4	14.2	33.4

• Metal hoop reel dimensions (Plug cover shell)



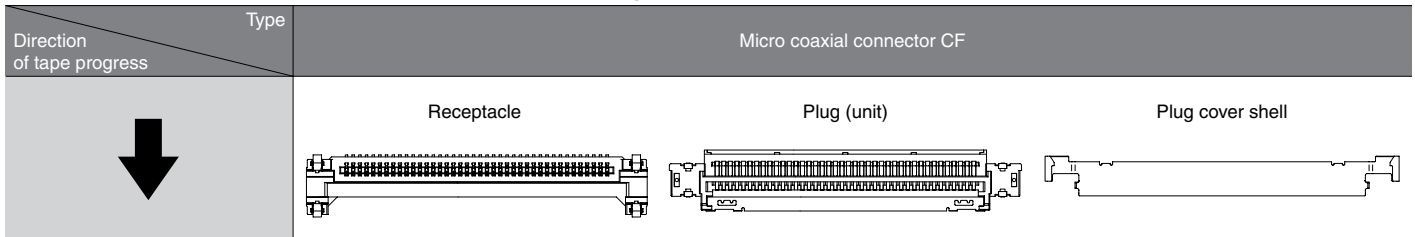
• Plastic reel dimensions (Conforming to EIAJ ET-7200B)



Dimension table (mm)

Plug cover shell	Number of pins	A	B
	40	29.0	26.0

• Connector orientation with respect to direction of progress of embossed tape



Please refer to the latest product specifications when designing your product.

Notes on Using Micro Coaxial Connectors

NOTES (Unit: mm)

■ Safety precautions

Observe the following safety precautions to prevent accidents and injuries.

1) The use of the connector outside of the specified rated current and breakdown voltage ranges may cause abnormal heating, smoke, and fire.

Never use the connector beyond the specified ranges of the product.

2) In order to avoid accidents, make sure you have thoroughly reviewed the specifications before use. Consult us if you plan to use the product in a way not covered by the specifications.

3) We are consistently striving to improve quality and reliability. However, the fact remains that electrical components and devices generally fail at a given statistical probability. Furthermore, their durability varies depending on where and how they are used. Please be sure to verify electrical components and devices under actual conditions before use. Continuously using them in a state of degraded performance may cause deterioration in insulation performance, thus resulting in abnormal heat generation, smoke generation, or fire. To avoid that, we ask you to implement safe designs that include redundancy, fire prevention, and malfunction prevention. Also, please conduct periodic maintenance so that no accidents resulting in injury or death, fire, or harm to society will be caused as a result of product failure or service life.

■ About plug

The plug of this product is wired by soldering the 0.25 mm pitch (CS)/0.4 mm pitch (CF) cable.

If you will be harnessing, carry it out based on the separately attached "Plug Assembly Procedures". Make sure to get familiar with and observe all the precautions in the procedures.

Note: If you would like "Plug Assembly Procedures", please inquire at one of our sales offices.

• Caution regarding harness handling procedures.

To prevent the cable from being severed and to prevent damage to the product, please handle carefully making sure not to apply undue stress to the base of the cable after connecting it and after mating the connector.

• Caution regarding harness design

To prevent the cable from being severed and to prevent damage to the product, please place and secure the cable in a way that prevents the base of the cable from becoming stressed.

■ About receptacle

• PC board design

Design the recommended foot pattern in order to secure the mechanical strength in the soldered areas of the terminal.

• About (CF)

Use all the soldering terminals as GND for connecting GND stably.

• Connector mounting

When mounting, if there is too much suction nozzle pressure, the molded and metal parts might deform and break.

Please check beforehand.

• Soldering

1) Manual soldering.

• Since this connector is the low profile type the amount of solder supplied should be closely monitored.

Too much solder during manual soldering may cause solder creeping near the contacting part or a short circuit with the shell (GND).

• Make sure that the soldering iron tip is heated within the temperature and time limits indicated in the specifications.

• Flux from the solder wire may adhere to the contact surfaces during soldering operations. After soldering, carefully check the contact surfaces and clean off any flux before use.

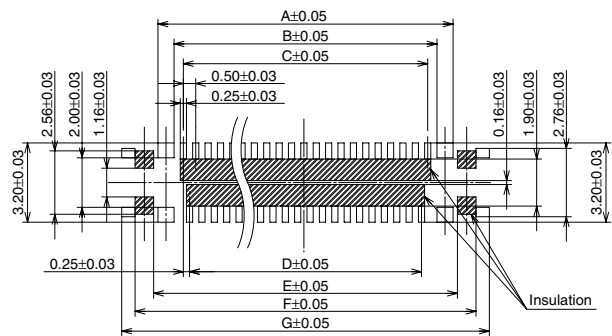
• Be aware that a load applied to the connector terminals while soldering may displace the contact.

• Thoroughly clean the iron tip.

CS series

• Receptacle

Recommended PC board pattern (mounting pad layout)
(Top view)



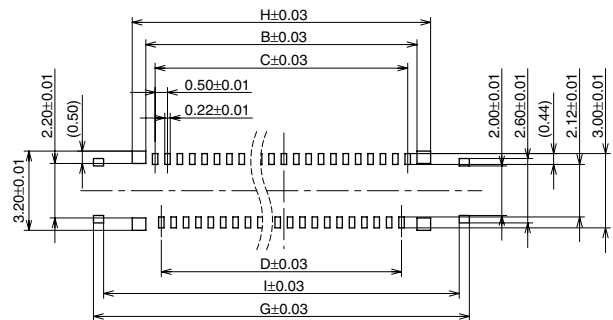
Recommended window size of metal mask

Metal mask thickness: When 120 μ m

(Signal terminal portion opening area ratio: 60%)

(GND terminal portion opening area ratio: 70%)

(Shell edge terminal portion at four corners opening area ratio: 60%)

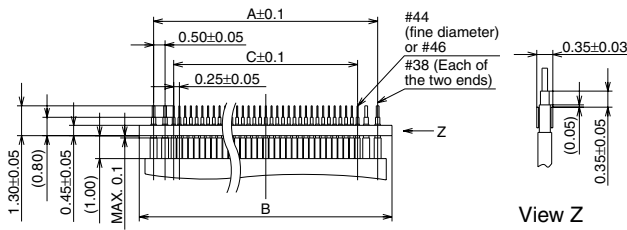


Dimension table (mm)

Number of pins/ dimension	A	B	C	D	E	F	G	H	I
21	7.05	5.75	5.00	4.50	7.40	8.90	9.98	6.85	9.16
41	12.05	10.75	10.00	9.50	12.40	13.90	14.98	11.85	14.16
51	14.55	13.25	12.50	12.00	14.90	16.40	17.48	14.35	16.66

• Plug

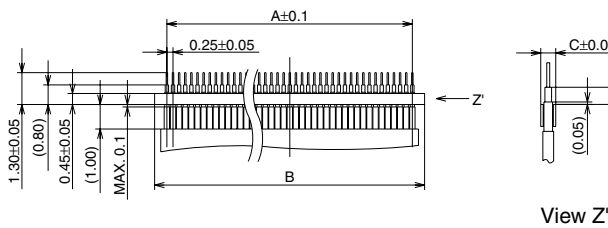
21, 41 pin contacts (#38 wire for power supply)
Recommended cable pattern



Dimension table (mm)

Number of pins/dimension	A	B	C
21	4.75	6.00	3.00
41	9.75	11.00	8.00

41 pin contacts/51 pin contacts (signal wire only)
Recommended cable pattern



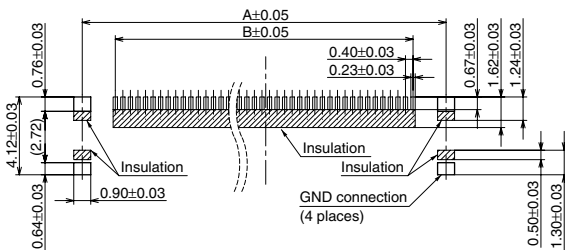
Dimension table (mm)

Number of pins/dimension	A	B	C
41	10.00	11.00	0.34
51	12.50	13.50	0.31

CF series

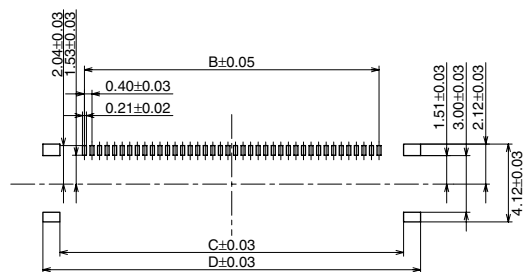
• Receptacle

Recommended PC board pattern (mounting pad layout)



Recommended window size of metal mask

Metal mask thickness: When 120µm
(Signal terminal portion opening area ratio: 70%)
(GND terminal portion opening area ratio: 80%)

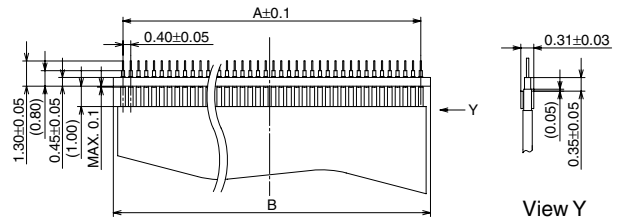


Dimension table (mm)

Number of pins/dimension	A	B	C	D
40	19.10	15.60	18.20	20.00

• Plug

Recommended cable pattern

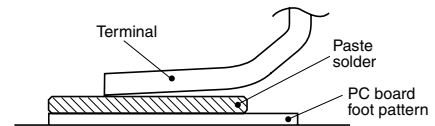


Dimension table (mm)

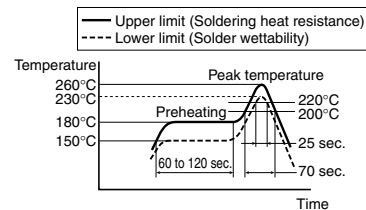
Number of pins/dimension	A	B
40	15.60	16.60

2) Reflow soldering

- Screen-printing is recommended for printing paste solder.
- To determine the relationship between the screen opening area and the PC board foot pattern area, refer to the diagrams in the recommended patterns for PC boards and metal masks. Make sure to use the terminal tip as a reference position when setting.
- Too much solder may cause solder creeping near the contacting part or a short circuit with the shell (GND).



- Consult us when using a screen-printing thickness other than that recommended.
- Depending on the size of the connector being used, self alignment may not be possible. Accordingly, carefully position the terminal with the PC board pattern.
- The recommended reflow temperature profile is given in the figure below



- The temperature is measured on the surface of the PC board near the connector terminal.
 - Certain solder and flux types may cause serious solder creeping. Solder and flux characteristics should be taken into consideration when setting the reflow soldering conditions.
 - Do not apply adhesive to secure the connector, because it can affect the spring action of the contact.
 - When coating the PC board after soldering the connector to prevent the deterioration of insulation, perform the coating in such a way so that the coating does not get on the connector.
- ### 3) Reworking on a soldered portion
- Finish reworking in one operation.
 - For reworking of the solder bridge, use a soldering iron with a flat tip. Do not add flux, otherwise, the flux may creep to the contact parts.
 - Use a soldering iron whose tip temperature is within the temperature range specified in the specifications.

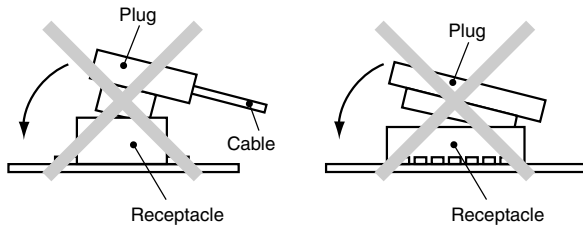
Notes on Using Micro Coaxial Connectors

4) Others

- Do not drop or handle the connector carelessly. Otherwise, the terminals may become deformed due to excessive force or applied solderability may degrade.
- When cutting or bending the PC board after mounting the connector, be careful that the soldered sections are subjected to excessive forces.

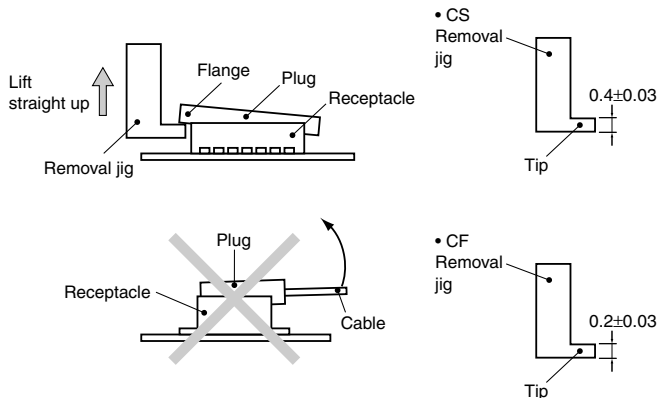
■ Insertion / Removal and mating retention of connectors

- Do not insert or remove the connector when it is not soldered. Also, forcibly applied external pressure on the terminals can weaken the adherence of the terminals to the molded part or cause the terminals to lose their evenness.
- Excessive prying-force applied to one end may cause product breakage and separation of the solder joints at the terminal. Excessive force applied for insertion in a pivot action as shown may also cause product breakage. Always align the connector with the mating part and slide it in parallel.



- Pushing the plug excessively when inserting it may deform and break the product.
- This product has a simple lock structure for mating. However, connectors may become unmated due to cable weight, cable reactive force, and impact by dropping, etc. Please take measures to prevent inadvertent connector disconnections at the equipment side.
- When removing the connector, do not pull the cable to avoid damaging the product.

Insert the tip of the removal jig under the flange of the plug and lift the jig straight up as shown below. (Removable from either the left or right side.) We recommend a tip thickness of 0.4 ± 0.03 mm (CS), 0.2 ± 0.03 mm (CF).



■ Other Notes

The connectors are not meant to be used for switching.

Please refer to the latest product specifications when designing your product.